

RoHS Compliant Product

Description

The SMG2306 utilized advanced processing techniques to achieve the lowest possible on-resistance, extremely efficient and cost-effectiveness device.

The SOT-23 package is universally used for all commercial-industrial applications

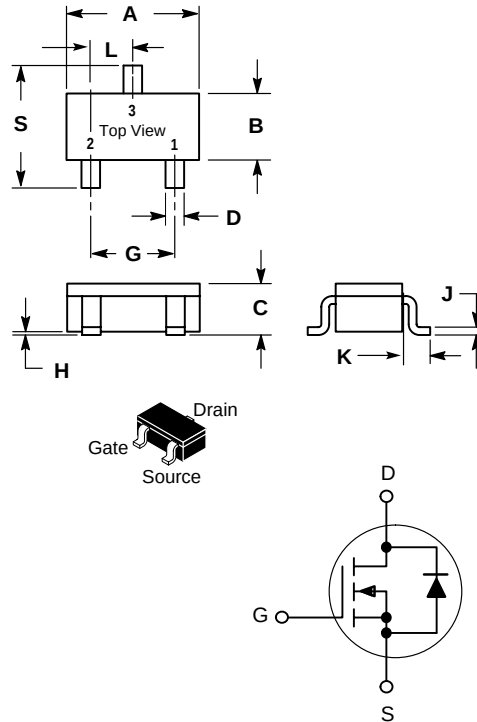
Features

- * Capable of 2.5V gate drive
- * Lower on-resistance
- * Reliable and Rugged

Applications

- * Power Management in Notebook Computer
- * Portable Equipment
- * Battery Powered System

Marking : 2306



SC-59		
Dim	Min	Max
A	2.70	3.10
B	1.40	1.60
C	1.00	1.30
D	0.35	0.50
G	1.70	2.10
H	0.00	0.10
J	0.10	0.26
K	0.20	0.60
L	0.85	1.15
S	2.40	2.80
All Dimension in mm		

Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current, ³ $V_{GS}@4.5V$	$I_D@T_A=25^\circ C$	5.3	A
Continuous Drain Current, ³ $V_{GS}@4.5V$	$I_D@T_A=70^\circ C$	4.3	A
Pulsed Drain Current	I_{DM}	10	A
Total Power Dissipation	$P_D@T_A=25^\circ C$	1.38	W
Linear Derating Factor		0.01	W/ $^\circ C$
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55~+150	$^\circ C$

Thermal Data

Parameter	Symbol	Ratings	Unit
Thermal Resistance Junction-ambient ³	R_{thj-a}	90	$^\circ C/W$

Electrical Characteristics($T_j=25^\circ C$ Unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Drain-Source Breakdown Voltage	BV_{DSS}	20	–	–	V	$V_{GS}=0V, I_D=250\mu A$
Breakdown Voltage Temp. Coefficient	$\Delta BV_{DS}/\Delta T_j$	–	0.1	–	V/ $^\circ C$	Reference to $25^\circ C, I_D=1mA$
Gate Threshold Voltage	$V_{GS(th)}$	0.5	–	1.2	V	$V_{DS}=V_{GS}, I_D=250\mu A$
Gate-Source Leakage Current	I_{GSS}	–	–	± 100	nA	$V_{GS}=\pm 12V$
Drain-Source Leakage Current ($T_j=25^\circ C$)	I_{DSS}	–	–	1	μA	$V_{DS}=20V, V_{GS}=0$
Drain-Source Leakage Current ($T_j=70^\circ C$)		–	–	10	μA	$V_{DS}=16V, V_{GS}=0$
Static Drain-Source On-Resistance ²	$R_{DS(ON)}$	–	–	30	$m\Omega$	$V_{GS}=10V, I_D=5.5A$
		–	–	35		$V_{GS}=4.5V, I_D=5.3A$
		–	–	50		$V_{GS}=2.5V, I_D=2.6A$
		–	–	90		$V_{GS}=1.8V, I_D=1A$
Total Gate Charge ²	Q_g	–	8.7	–	nC	$I_D=5.3A$ $V_{DS}=10V$ $V_{GS}=4.5V$
Gate-Source Charge	Q_{gs}	–	1.5	–		
Gate-Drain ("Miller") Charge	Q_{gd}	–	3.6	–		
Turn-on Delay Time ²	$T_{d(ON)}$	–	6	–	nS	$V_{DS}=15V$ $I_D=1A$ $V_{GS}=10V$ $R_G=2\Omega$ $R_D=15\Omega$
Rise Time	T_r	–	14	–		
Turn-off Delay Time	$T_{d(OFF)}$	–	18.4	–		
Fall Time	T_f	–	2.8	–		
Input Capacitance	C_{iss}	–	603	–	pF	$V_{GS}=0V$ $V_{DS}=15V$ $f=1.0MHz$
Output Capacitance	C_{oss}	–	144	–		
Reverse Transfer Capacitance	C_{rss}	–	111	–		
Forward Transconductance	G_{fs}	–	13	–	S	$V_{DS}=5V, I_D=5.3A$

Source-Drain Diode

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Forward On Voltage ²	V_{SD}	–	–	1.2	V	$I_S=1.2A, V_{GS}=0V.$
Reverse Recovery Time	T_{rr}	–	16.8	–	nS	$I_S=5A, V_{GS}=0V$ $dl/dt=100A/\mu S$
Reverse Recovery Charge	Q_{rr}	–	11	–	nC	

Notes: 1.Pulse width limited by Max. junction temperature.

2.Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

3.Surface mounted on 1 inch² copper pad of FR4 board; $270^\circ C/W$ when mounted on min. copper pad.

Characteristics Curve

